

iW-RainboW-G34S/G37S
i.MX 8M Mini/Nano Pico ITX SBC HEAT SINK
ORDERING PART NUMBER: iW-HSKALU-CLASLR-SB04

RELEASE HISTORY			
REL	CHANGES	DATE	BY
1.0	INITIAL RELEASE	18 AUG. 2021	IQBAL

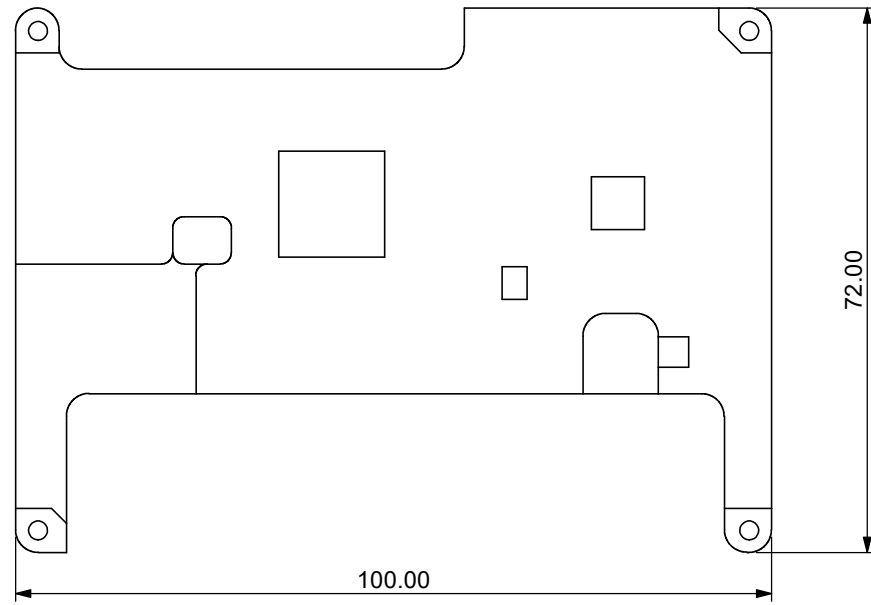


Fig 1.1

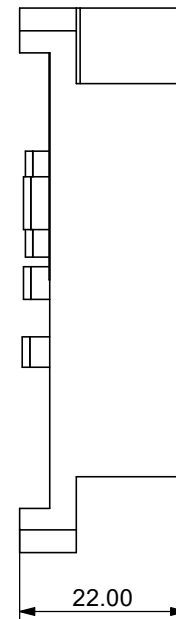


Fig 1.2

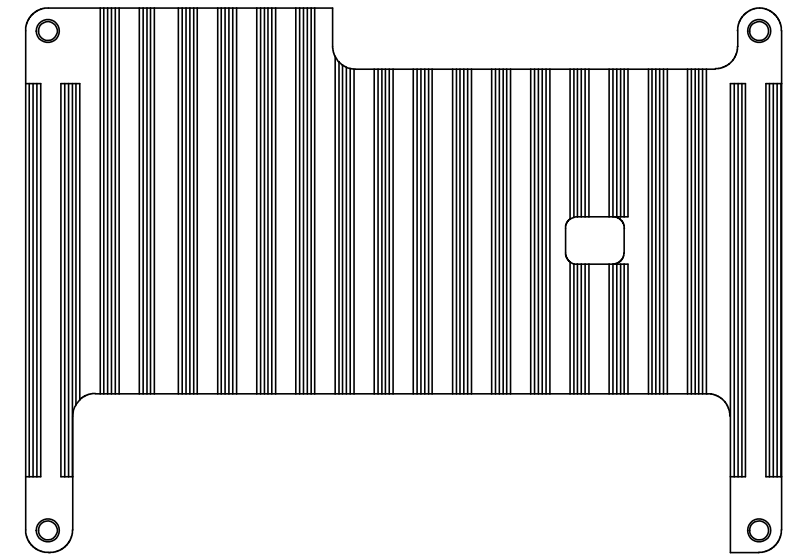


Fig 1.3

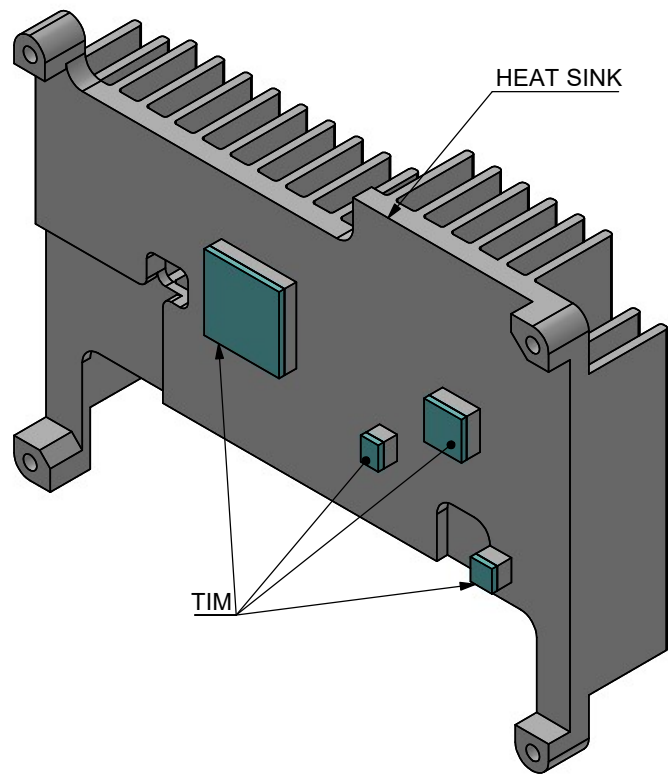


Fig 1.4

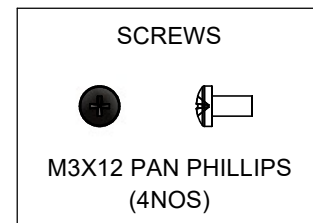


Fig 1.5

NOTES:
 ALL DIMENSIONS ARE IN mm.
 SCALE: 1:1

DRAWN BY	IQBAL
CHECKED BY	GANGADHAR
APPROVED BY	IMMANUEL
THIS DRAWING SHEET IS PROPERITY OF IWAVE SYSTEMS TECHNOLOGIES Pvt. Ltd.	
GENERAL TOLERANCES :	
X: ± 0.25	
.X: ± 0.1	
.XX: ± 0.01	

		iWave System Technologies Private Limited, 7/B, 29th Main, BTM Layout, 2nd Stage, Bangalore-560076, India.	
		DRAWING NO: iW-HSKALU-CLASLR-SB04-DS-R1.0-REL1.0	
MATERIAL : AL 6063-T5 ALLOY		WEIGHT: 103 g	
FINISH : CLEAR ANODIZED			
TITLE: G34S/G37S-i.MX 8M Mini/Nano Pico ITX SBC HEAT SINK		REV: 1.0	REL: 1.0
DATE : 18 AUG. 2021		SHEET 1 OF 1	

TABLE1.1: TIM SPECIFICATIONS	
MATERIAL	SILICONE RUBBER (BASE MATERIAL)
THERMAL CONDUCTIVITY	6.2 W/mK
FLAME RATING	UL 94 V-0
HARDNESS	50 Shore 00
WORKING TEMP.	-50~+150 °C
ROHS	YES